



## **Disclaimer**

This is a presentation of general information relating to the current activities of AEM Holdings Ltd. ("AEM"). It is given in summary form and does not purport to be complete.

This presentation may contain forward-looking statements which are subject to risks and uncertainties. Actual future performance, outcomes and results may differ materially from those expressed in these forward-looking statements as a result of a number of risks, uncertainties and assumptions. Representative examples of these factors include (without limitation) general industry and economic conditions, interest rate trends, cost of capital and capital availability, competition from other companies, shifts in customer demands, customers and partners, changes in operating expenses, governmental and public policy changes, and the continued availability of financing.

Accordingly, such statements are not and should not be construed as a representation as to the future of AEM, and are not intended to be profit forecasts, estimations or projections of future performance and should not be regarded as such.

No reliance should therefore be placed on these forward-looking statements, which are based on the current views of the management of AEM. The presentation is also not to be relied upon as advice to investors or potential investors and does not take into account the investment objectives, financial situation or needs of any particular investor. AEM accepts no responsibility whatsoever with respect to the use of this document or any part thereof.

In this presentation, all \$ dollar amounts are in Singapore dollars unless otherwise specified.

## **AEM Corporate Profile**

AEM is a global leader in the fast growing **Test 2.0** market, delivering application-specific intelligent system test and handling solutions for semiconductor and electronics companies serving the advanced computing, 5G, and AI markets.





### Leader in Fast Growing Test 2.0 Market

Test 2.0 growth is driven by advanced packaging & integrated logic.
AEM has over **1,000** Test 2.0 tools in production



## Full Stack Technology

Delivering **composable** technologies and solutions for advanced, integrated semiconductor test needs



# Deploy at Scale

Critical delivery capabilities giving our customers a reduced time to market



## 2016-2022\* Rev. CAGR

**52%** 

FY2022 Results
Revenue: **\$\$870.5M**PBT: **\$\$158.7M**FY2023 Revenue Guidance: **\$\$500M** 



### Listed on SGX

Market Cap: ~S\$1.05B\* AEM Holdings Ltd. (SGD: AWX) (USD: XWA)

\* As at 24 Feb 2023

# FY2022 was a record revenue year, with 54% growth in revenue vs. 2021



Revenue

**S\$870.5M** 

+54% vs FY2021

**PBT** 

S\$158.7M

+43% vs FY2021

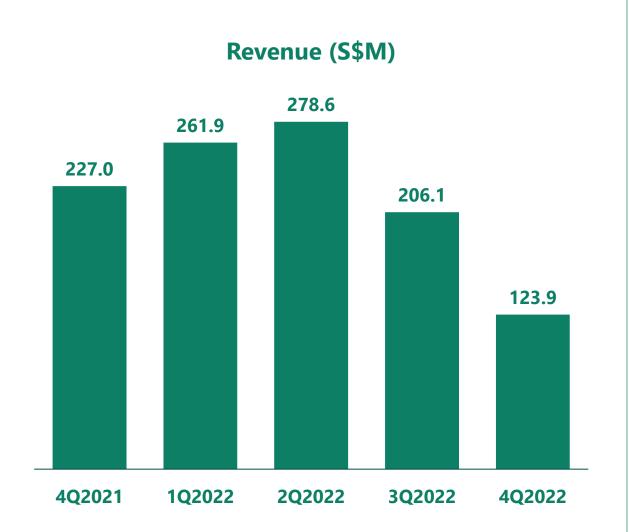
NAV per share

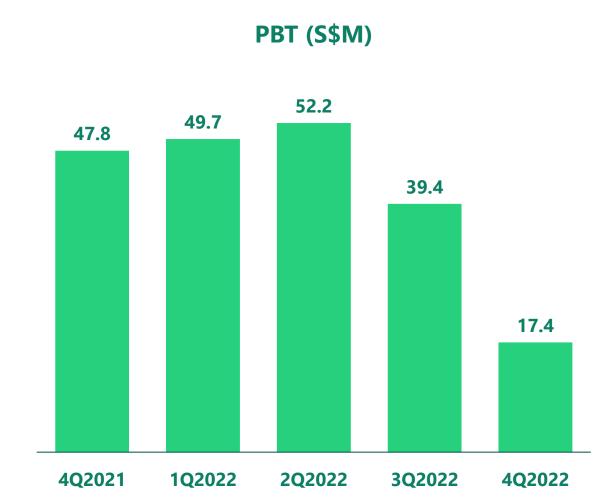
**157.1 cents** 

+21% vs FY2021

# **Quarterly Revenue & PBT**



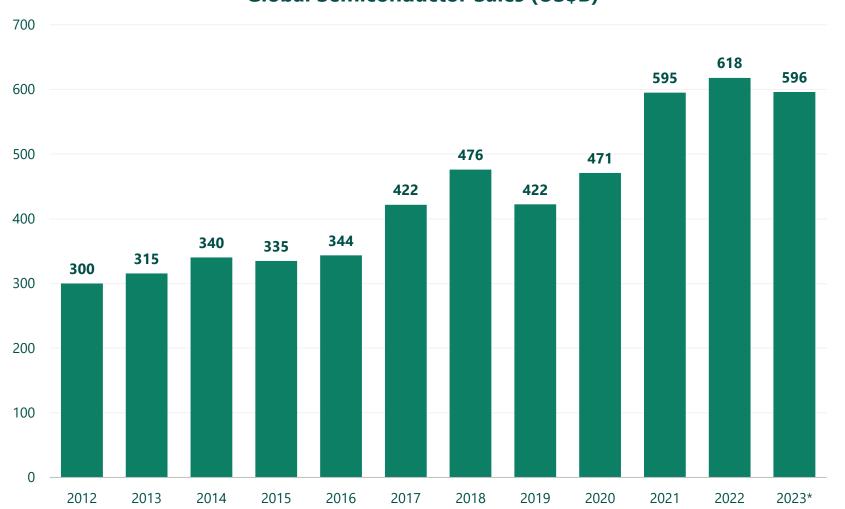




# Semiconductor market pullback due to inventory digestion and recessionary fears started in latter half of 2022 and expected to last through 1H 2023







- 2022 was a record year for semiconductor sales, yet the latter half of 2022 and 1H 2023 are showing signs of a pullback driven by recessionary concerns, interest rate hikes, and geopolitical uncertainty
- Bifurcation in semiconductor demand is appearing in the short-term, with logic devices / XPUs showing a weakening demand while automotive and industrial power applications showing strong demand
- We believe the industry will rebound in 2H 2023, early 2024 and will continue its growth trajectory to reach US\$1 trillion by the early 2030s as the longer-term trends in high performance computing, artificial intelligence, electrification of vehicles, and 5G communications march forward, driving the need for Test 2.0 solutions

Source: Gartner, Inc.

# The industry megatrends continue to point to secular growth for semiconductor test, despite short-term pullback



Semiconductor manufacturers are designing next generation devices, and engaging in developing production solutions to overcome their test challenges

Industry Megatrends



### **5G**

High-speed, low-latency, and omnipresent connectivity opens a vast array of new applications and use cases



### **Artificial Intelligence**

Growth of AI enables new business models and unlocks increasing value from data



#### **IoT & Cloudification**

Proliferation of IoT enabled devices and the cloudification of data requires increased power in the cloud and at the edge



#### **Automotive**

Electrification of vehicles, introduction of autonomous driving capabilities, and digitalization

Device Volumes Increasing



**Test Challenges** 



Increasing
Device
Complexity



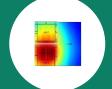
Increasing Power Requirement



Adoption of Advanced Packaging



Increasing Test
Development
Times



Increasing Thermal Challenges



Increasing Test
Coverage
Requirements

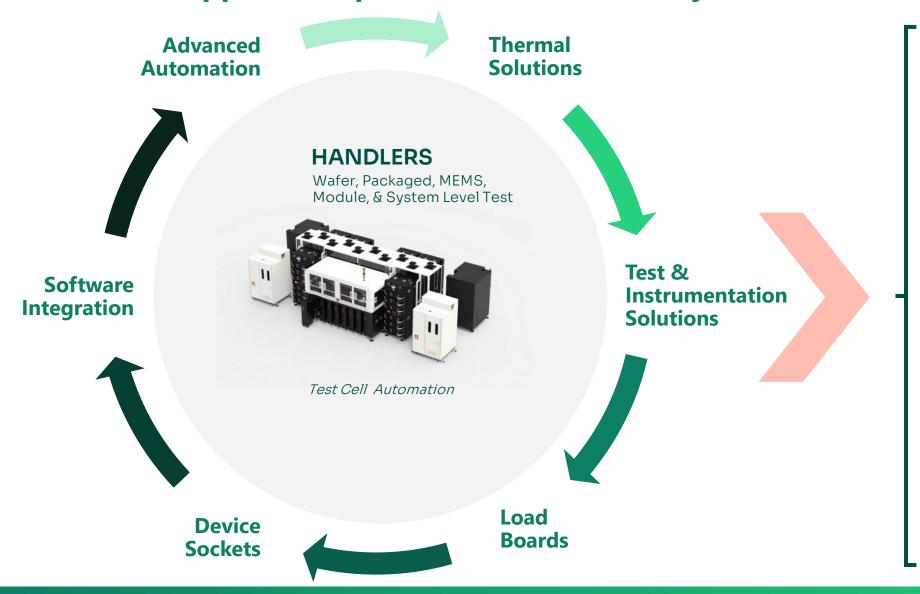
Device Test Times Increasing



Growth In Test Spend

# AEM's Test 2.0 composable solution approach is winning customers from HPC / AI, application processors, and memory





**CUSTOMER MARKETS** 

**Memory** 

**High Perf. Compute / Al** 

**Application Processor** 

**CUSTOMER PROGRAMS** 

**High Perf. Automated BI** 

**Slot-based FT** 

**High Perf. SLT** 



- Recorded highest annual revenue at **S\$870.5M** (+54% y-o-y) and profit before tax at **S\$158.7M** (+43% y-o-y), exceeding revenue guidance for FY2022 of between S\$820M and S\$850M
- FY2023 target revenue guidance of **S\$500M** that may be revised as the Group gains visibility into the second half of the year
- 2023 will be a year of transformation for the Group, where the previously announced wins for programs in high performance compute / AI, application processors, and memory will more than double our non-key customer revenues in 2023 and lead to secular growth in 2024 and beyond
- The Group expanded its operations to a 365,000 sq. ft. facility in Penang, and will use this to accommodate the mid- to long-term demand seen from its growing customer base

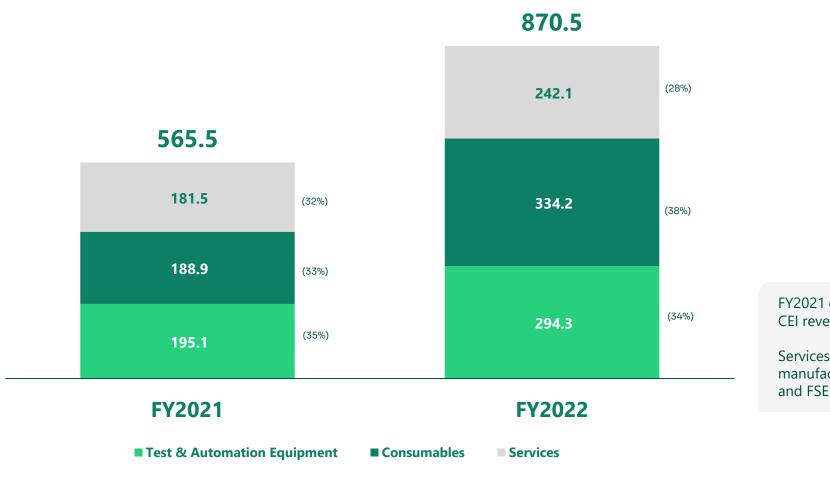


## **Revenue Mix**

Consumables and Equipment revenue increase by more than 60%







FY2021 comprises 9 months of CEI revenue only

Services comprises manufacturing, engineering, and FSE revenue

## **A Robust Balance Sheet**

## Sound capital structure – Debt/Equity ratio of 0.3X



	As	As at	
	Dec'22	Dec'21 S\$M	
	S\$M		
Cash	127.8	216.2	
Inventories	367.7	204.9	
Trade and other receivables	92.9	127.9	
Total Assets	805.6	710.5	
Trade and other payables	118.9	182.6	
Financial Liabilities	143.3	81.3	
Shareholders' Equity	485.0	402.5	
in SG Cents			
NTA per share	122.0	98.3	
NAV per share	157.1	130.0	
Debt/ Equity	0.3x	0.2x	
No. of Shares less treasury shares ('000)	308,752	309,649	

## **Highlights**

### Inventories (+S\$162.8M)

Increased mainly due to longer dated, non-cancellable purchase orders, entered with our key customer

#### **Financial Liabilities (+S\$62.0M)**

Increased mainly due from

- Proceeds of existing loan facility
- New property leases entered
- Consolidation of Nestek

### **Shareholders' Equity (+S\$82.5M)**

Increased due to profit contribution in FY2022 of S\$127.3M partially offset by dividends paid in 2022 of S\$36.2M

## **FY2022 Source and Applications of Funds**



Negative change in working capital resulted from higher inventory level to ensure parts and components availability

for longer dated, non-cancellable purchase orders

Operating Activities
Outflow: \$\$32.1M

**Investing Activities**Outflow: S\$38.4M

**Financing Activities**Outflow: S\$18.6M

S\$M	FY2022	FY2021
Beginning Cash	216.2	134.8
Profit After Tax	127.3	92.1
Depreciation & Amortisation	23.5	14.5
Changes in working capital & others	(182.9)	(51.6)
Capital expenditure and others	(9.1)	(3.5)
Addition of intangible assets	(14.7)	(12.5)
Acquisition of investments	(14.6)	(69.2)
Share buyback	(5.3)	(4.6)
Proceeds from ESOS exercised	0.3	2.6
Proceed from issuance of shares	-	103.1
Dividends paid	(36.2)	(18.6)
Borrowings & other financing, net	22.6	31.0
Effect of FX translation	0.7	(1.8)
Ending Cash	127.8	216.2
Net Cash	19.7	152.9

## **Highlights**

Lower cash balance of S\$127.8M (decreased by S\$88.4M), largely due to:

- Operating Activities outflow of S\$32.1M:
  - Higher inventory level in FY2022 to ensure parts and components availability for longer dated, non-cancellable purchase orders; offset by
  - Profit contribution of S\$127.3M
- Investing Activities outflow of S\$38.4M:
  - Investment in Nestek
  - CAPEX spend and R&D activities
- Financing Activities outflow of S\$18.6M:
  - FY2021 Final dividends & FY2022 Interim dividends paid; and
  - Repayment of borrowings & leases; offset by
  - Proceed from existing facility



# Thank You

#### **Investor Relations Contact**

Samir MOWLA samir.mowla@aem.com.sg

### **Financial PR Pte Ltd**

Kamal SAMUEL / Shivam SARAF / Urvija DIWAN Tel: 6438 2990 / Fax: 6438 0064 kamal@financialpr.com.sg shivam@financialpr.com.sg urvija@financialpr.com.sg